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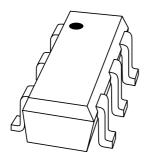
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Kind regards,

Team Nexperia

## **DISCRETE SEMICONDUCTORS**

## DATA SHEET



# PUMF11 NPN resistor-equipped transistor; PNP general purpose transistor

Product data sheet 2002 Apr 09



## NPN resistor-equipped transistor; PNP general purpose transistor

PUMF11

#### **FEATURES**

- Resistor-equipped transistor and general purpose transistor in one package
- 100 mA collector current
- 50 V collector-emitter voltage
- 300 mW total power dissipation
- SOT363 package; replaces two SOT323 (SC-70) packaged devices on same PCB area
- · Reduced pick and place costs.

#### **APPLICATIONS**

- Power management switch for portable equipment, e.g. cellular phone and CD player
- · Switch for regulator.

#### **DESCRIPTION**

NPN resistor-equipped transistor and a PNP general purpose transistor in a SOT363 (SC-88) plastic package.

#### **MARKING**

TYPE NUMBER	MARKING CODE <sup>(1)</sup>
PUMF11	R1*

#### Note

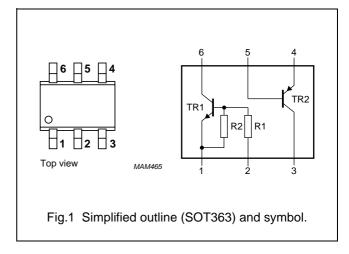
- 1. \* = p: Made in Hong Kong.
  - \* = t: Made in Malaysia.

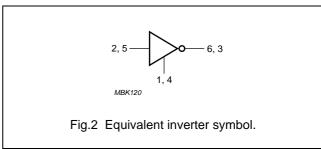
#### **QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
TR1 (NPN)			
V <sub>CEO</sub>	collector-emitter voltage	50	V
Io	output current (DC)	100	mA
R1	bias resistor	22	kΩ
R2	bias resistor	47	kΩ
TR2 (PNP)	•	•	
V <sub>CEO</sub>	collector-emitter voltage	50	V
I <sub>C</sub>	collector current (DC)	100	mA
I <sub>CM</sub>	peak collector current 200 mA		mA

#### **PINNING**

PIN	DESCRIPTION		
1, 4	emitter	TR1; TR2	
2, 5	base	TR1; TR2	
6, 3	collector	TR1; TR2	





# NPN resistor-equipped transistor; PNP general purpose transistor

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#### **LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT		
Per transist	Per transistor						
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	200	mW		
T <sub>stg</sub>	storage temperature		-65	+150	°C		
T <sub>j</sub>	junction temperature		-	150	°C		
T <sub>amb</sub>	operating ambient temperature		-65	+150	°C		
TR1 (NPN)							
V <sub>CBO</sub>	collector-base voltage	open emitter	_	50	V		
V <sub>CEO</sub>	collector-emitter voltage	open base	_	50	V		
V <sub>EBO</sub>	emitter-base voltage	open collector	_	10	V		
Vi	input voltage						
	positive		_	+40	V		
	negative		_	-10	V		
Io	output current (DC)		-	100	mA		
I <sub>CM</sub>	peak collector current		_	100	mA		
TR2 (PNP)							
V <sub>CBO</sub>	collector-base voltage	open emitter	_	-50	V		
V <sub>CEO</sub>	collector-emitter voltage	open base	_	-40	V		
V <sub>EBO</sub>	emitter-base voltage	open collector	_	-5	V		
I <sub>C</sub>	collector current (DC)		_	-100	mA		
I <sub>CM</sub>	peak collector current		_	-200	mA		
Per device			•				
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C; note 1	_	300	mW		

#### Note

1. Device mounted on an FR4 printed-circuit board.

#### THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R <sub>th j-a</sub>	thermal resistance from junction to ambient	in free air; note 1	416	K/W

#### Note

1. Device mounted on an FR4 printed-circuit board.

## NPN resistor-equipped transistor; PNP general purpose transistor

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#### **CHARACTERISTICS**

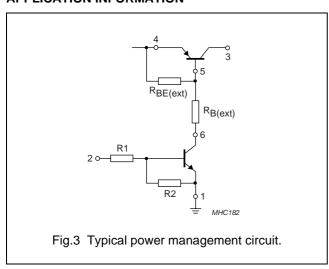
 $T_{amb}$  = 25 °C unless otherwise specified.

SYMBOL	PARAMETER CONDITIONS		MIN.	TYP.	MAX.	UNIT
TR1 (NPN)						
I <sub>CBO</sub>	collector-base cut-off current	V <sub>CB</sub> = 50 V; I <sub>E</sub> = 0	_	_	100	nA
I <sub>CEO</sub>	collector-emitter cut-off current	V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0	_	-	1	μΑ
		V <sub>CE</sub> = 30 V; I <sub>B</sub> = 0; T <sub>j</sub> = 150 °C	_	-	50	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = 5 \text{ V}; I_{C} = 0$	_	-	0.12	mA
h <sub>FE</sub>	DC current gain	$V_{CE} = 5 \text{ V}; I_{C} = 5 \text{ mA}$	80	-	-	
V <sub>CEsat</sub>	collector-emitter saturation voltage	$I_C = 10 \text{ mA}; I_B = 0.5 \text{ mA}$	_	_	150	mV
V <sub>i(off)</sub>	input off voltage	$V_{CE} = 5 \text{ V}; I_{C} = 100 \mu\text{A}$	_	0.9	0.5	V
V <sub>i(on)</sub>	input on voltage	V <sub>CE</sub> = 0.3 V; I <sub>C</sub> = 2 mA	2	1.1	_	V
R1	input resistor		15.4	22	28.6	kΩ
R2 R1	resistor ratio		1.7	2.1	2.6	
C <sub>c</sub>	collector capacitance	V <sub>CB</sub> = 10 V; I <sub>E</sub> = i <sub>e</sub> = 0; f = 1 MHz	_	_	2.5	pF
TR2 (PNP)						
I <sub>CBO</sub>	collector-base cut-off current	$V_{CB} = -30 \text{ V}; I_E = 0$	_	-	-100	nA
I <sub>CEO</sub>	collector-emitter cut-off current	$V_{CB} = -30 \text{ V}; I_B = 0; T_j = 150 ^{\circ}\text{C}$	_	-	-10	μΑ
I <sub>EBO</sub>	emitter-base cut-off current	$V_{EB} = -4 \text{ V; } I_C = 0$	_	-	-100	nA
h <sub>FE</sub>	DC current gain	$V_{CE} = -6 \text{ V}; I_{C} = -1 \text{ mA}$	120	_	_	
V <sub>CEsat</sub>	saturation voltage	$I_C = -50 \text{ mA}$ ; $I_B = -5 \text{ mA}$ ; note 1	_	_	-200	mV
C <sub>c</sub>	collector capacitance	$V_{CB} = -12 \text{ V}; I_E = i_e = 0; f = 1 \text{ MHz}$	_	_	2.2	pF
f <sub>T</sub>	transition frequency	$V_{CE} = -12 \text{ V}; I_{C} = -2 \text{ mA}; f = 100 \text{ MHz}$	100	_	_	MHz

#### Note

1. Device mounted on an FR4 printed-circuit board.

#### **APPLICATION INFORMATION**



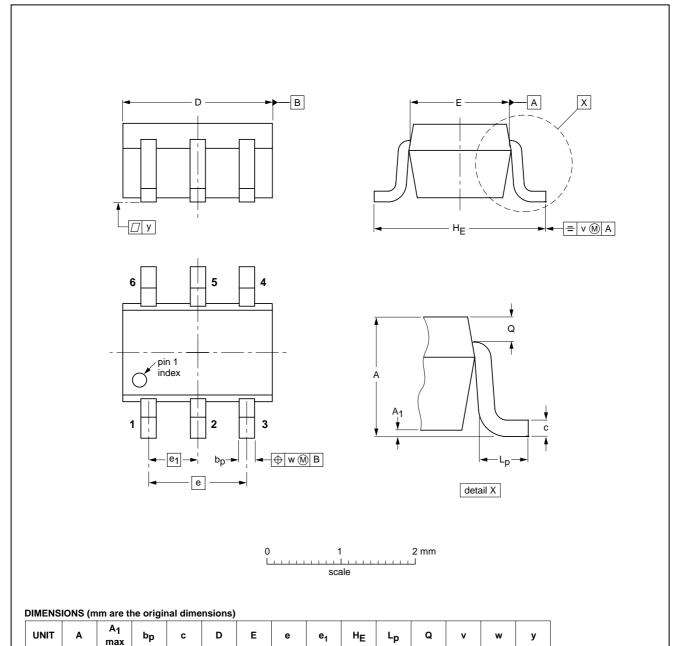
## NPN resistor-equipped transistor; PNP general purpose transistor

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#### **PACKAGE OUTLINE**

Plastic surface mounted package; 6 leads

**SOT363** 



OUTLINE	REFERENCES		EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT363			SC-88		$ \  \   \bigoplus   \big($	97-02-28

0.65

0.45 0.15 0.25 0.15

0.2

0.1

2002 Apr 09 5

0.25 0.10 2.2 1.8 1.35 1.15

1.3

0.30

0.20

1.1 0.8

0.1

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#### **DATA SHEET STATUS**

DOCUMENT STATUS <sup>(1)</sup>	PRODUCT STATUS <sup>(2)</sup>	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

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#### **Customer notification**

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#### **Contact information**

For additional information please visit: http://www.nxp.com

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